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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/763,827	01/22/2004	Ching Tong Sim	STL11284	7686	
7590 04/06/2006		EXAMINER			
Jennifer M. Buenzow			STAFIRA, MICHAEL PATRICK		
SeagateTechnology LLC Intellectual Property Dept SHK2LG		ART UNIT	PAPER NUMBER		
1280 Disc Drive			2877		
Shakopee, MN	N 55379-1863		DATE MAILED: 04/06/2006	DATE MAILED: 04/06/2006	

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)					
	10/763,827	SIM ET AL.					
Office Action Summary	Examiner	Art Unit					
	Michael P. Stafira	2877					
The MAILING DATE of this communication ap Period for Reply	opears on the cover sheet with the	correspondence address					
A SHORTENED STATUTORY PERIOD FOR REP WHICHEVER IS LONGER, FROM THE MAILING I - Extensions of time may be available under the provisions of 37 CFR 1 after SIX (6) MONTHS from the mailing date of this communication. If NO period for reply is specified above, the maximum statutory perio - Failure to reply within the set or extended period for reply will, by statu. Any reply received by the Office later than three months after the mail earned patent term adjustment. See 37 CFR 1.704(b).	DATE OF THIS COMMUNICATIO  .136(a). In no event, however, may a reply be tind  d will apply and will expire SIX (6) MONTHS from te, cause the application to become ABANDONE	N. nely filed the mailing date of this communication. ED (35 U.S.C. § 133).					
Status							
1) Responsive to communication(s) filed on							
·— · _—	is action is non-final.						
,	·						
, <u> </u>	closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213.						
Disposition of Claims							
4) Claim(s) 1-24 is/are pending in the application	n.						
4a) Of the above claim(s) is/are withdrawn from consideration.							
5) Claim(s) is/are allowed.							
6)⊠ Claim(s) <u>1-3,7-10 and 21-24</u> is/are rejected.							
7) Claim(s) <u>4-6 and 11-20</u> is/are objected to.							
8) Claim(s) are subject to restriction and	or election requirement.						
Application Papers							
9) The specification is objected to by the Examin	ner						
·— , · · · · ·		d to by the Examiner.					
10)⊠ The drawing(s) filed on <u>23 January 2004</u> is/are: a)⊠ accepted or b)□ objected to by the Examiner.  Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).							
Replacement drawing sheet(s) including the corre							
11) The oath or declaration is objected to by the							
Priority under 35 U.S.C. § 119							
·	on priority under 35 U.S.C. & 110/s	u)_(d) or (f)					
	12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).						
	a) All b) Some * c) None of:						
_ , , , ,	<ul> <li>1. Certified copies of the priority documents have been received.</li> <li>2. Certified copies of the priority documents have been received in Application No</li> </ul>						
3. Copies of the certified copies of the pr							
application from the International Bure		ca iii ans National Stage					
* See the attached detailed Office action for a li		ed					
See the attached detailed Office action for a ni	st of the certified copies flot recon-	ou.					
Attachment(s)							
1) X Notice of References Cited (PTO-892)	4) 🔲 Interview Summar	v (PTO-413)					
2) Notice of Draftsperson's Patent Drawing Review (PTO-948)	Paper No(s)/Mail [	Date					
3) 🔯 Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) 5) 🔛 Notice of Informal Patent Application (PTO-15)							
Paper No(s)/Mail Date <u>1/23/2004</u> . 6) U Other:							

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### **DETAILED ACTION**

## Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

2. Claims 1-3, 7-10, 21 are rejected under 35 U.S.C. 102(b) as being anticipated by Sepai et al. ('870).

#### Claim 1

Sepai et al. ('870) discloses a method by steps comprising comparing electronically a reflected light intensity transition region with a predetermined reflected light intensity transition region threshold to determine compliance of a component (Col. 10-11, lines 49-24).

## Claim 2

Sepai et al. ('870) further discloses the component is connected to a printed circuit board assembly, and in which the reflected light intensity transition region is an intensity of light reflected off a meniscus of a solder joint formed between the component and an associated solder pad of the printed circuit board assembly (Col. 7, lines 41-55), wherein the steps further discloses ascertaining a status of the component at a predetermined component site of the printed circuit board assembly; characterizing adherence of the intensity of light reflected off the meniscus to the predetermined light intensity transition region threshold (Col. 11, lines 1-44); and determining compliance of the component connected to the printed circuit board assembly based

on the characterization of the adherence of the intensity of light reflected off the meniscus to the threshold (Col. 11-12, lines 45-39).

#### Claim 3

Sepai et al. ('870) further discloses the status of the component at the predetermined component site of the printed circuit board assembly is a presence status, wherein the method proceeds to the characterizing step when the component present substantially conforms to a predetermined component footprint (Col. 11-12, lines 45-39).

#### Claim 7

Sepai et al. ('870) further discloses the status of the component at the predetermined component site of the printed circuit board assembly is a presence status, wherein the method proceeds to the determining step when the component present fails to substantially conform with a predetermined component footprint, wherein the determining step determines the component to be non-compliant and identifies the printed circuit board assembly as a non-compliant printed circuit board assembly (Col. 11-12, lines 45-39).

## Claim 8

Sepai et al. ('870) further discloses the status of the component at the predetermined component site of the printed circuit board assembly is a non-presence status, wherein the determining step determines the non-presence status of the component to be compliant and identifies the printed circuit board assembly as a compliant printed circuit board assembly (Col. 11-12, lines 45-39).

#### Claim 9

Sepai et al. ('870) further discloses the status of the component at the predetermined

component site of the printed circuit board assembly is a non-presence status, wherein the determining step determines the non-presence status of the component to be non-compliant and identifies the printed circuit board assembly as a non-compliant printed circuit board assembly (Col. 11-12, lines 45-39).

#### Claim 10

Sepai et al. ('870) further discloses the meniscus of the solder joint is characterized as missing by the characterizing step, and in which the determination step determines the missing meniscus to be a non-compliant component and identifies the printed circuit board assembly as a non-compliant printed circuit board assembly (Col. 11-12, lines 45-39).

#### Claim 21

Sepai et al. ('870) discloses a light source (Fig. 1, Ref. 28) illuminating the component of the printed circuit board assembly (Fig. 1, Ref. 20) as well as the solder joint connecting the component to the printed circuit board assembly (Col. 7, lines 41-55); a processor controlled (Fig. 1, Ref. 46) vision system responsive to the light source (Fig. 1, Ref. 28); an alignment apparatus (Fig. 1, Ref. 14) controlled by a processor (Fig. 1, Ref. 46) supporting the vision system, the alignment apparatus aligning the vision system relative to the solder joint and the component (Col. 7-8, lines 64-38); and decision software programmed (Fig. 1, Ref. 52) into the processor responsive to the vision system determining compliance of the component connected to the printed circuit board assembly based on a shadow projection of the solder joint to determine compliance of the printed circuit board assembly (Col. 11-12, lines 45-39).

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3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

- (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 4. Claims 22-24 are rejected under 35 U.S.C. 103(a) as being unpatentable over Schimanaski ('912) in view of Sepai et al. ('870).

#### Claim 22

Schimanaski ('912) discloses a head-disc assembly (Col. 8, lines 65-66); and a compliant printed circuit board assembly (Fig. 1, Ref. 32) attached to the head-disc assembly (Fig. 1, Ref. 46; note: the head-disc assembly is attached to the printed circuit board through electrical connections), compliance of the printed circuit board assembly determined by means for determining compliance of a printed circuit board assembly through steps for determining compliance of a component connected to a printed circuit board assembly (Col. 2-3, lines 48-28).

# Claim 23

Schimanaski ('912) substantially teaches the claimed invention except that it does not show a light source illuminating the component of the printed circuit board assembly as well as the solder joint connecting the component to the printed circuit board assembly; a processor controlled vision system responsive to the light source; an alignment apparatus controlled by a processor supporting the vision system, the alignment apparatus aligning the vision system relative to the solder joint and the component; and decision software programmed into the processor responsive to the vision system determining compliance of the component connected

to the printed circuit board assembly based on a shadow projection of the solder joint to determine compliance of the printed circuit board assembly. Sepai et al. ('870) shows that it is known to provide a light source (Fig. 1, Ref. 28) illuminating the component of the printed circuit board assembly (Fig. 1, Ref. 20) as well as the solder joint connecting the component to the printed circuit board assembly (Col. 7, lines 41-55); a processor controlled (Fig. 1, Ref. 46) vision system responsive to the light source (Fig. 1, Ref. 28); an alignment apparatus (Fig. 1, Ref. 14) controlled by a processor (Fig. 1, Ref. 46) supporting the vision system, the alignment apparatus aligning the vision system relative to the solder joint and the component (Col. 7-8, lines 64-38); and decision software programmed (Fig. 1, Ref. 52) into the processor responsive to the vision system determining compliance of the component connected to the printed circuit board assembly based on a shadow projection of the solder joint to determine compliance of the printed circuit board assembly (Col. 11-12, lines 45-39) for an optical inspection apparatus for printed circuit boards. It would have been obvious to combine the device of Schimanaski ('912) with the optical elements listed above with Sepai et al. ('870) for the purpose of providing an optical inspection apparatus that inspects the surface of a printed circuit board, therefore the inspection of defects on the surface which will decrease the amount of printed circuit boards that are have defects from being shipped the end user.

#### Claim 24

Schimanaski ('912) substantially teaches the claimed invention except that it does not show a component connected to a printed circuit board assembly comprise: ascertaining a status of the component at a predetermined component site of the printed circuit board assembly; comparing electronically a reflected light intensity transition region with a predetermined

reflected light intensity transition region threshold, wherein the reflected light intensity transition region is an intensity of light reflected off a meniscus of a solder joint formed between the component and an associated solder pad of the printed circuit board assembly; characterizing adherence of the intensity of light reflected off the meniscus to the threshold; and determining compliance of the component connected to the printed circuit board assembly based on the characterization of the adherence of the intensity of light reflected off the meniscus to the threshold. Sepai et al. ('870) shows that it is known to provide ascertaining a status of the component at a predetermined component site of the printed circuit board assembly (Col. 10-11, lines 49-24); comparing electronically a reflected light intensity transition region with a predetermined reflected light intensity transition region threshold, wherein the reflected light intensity transition region is an intensity of light reflected off a meniscus of a solder joint formed between the component and an associated solder pad of the printed circuit board assembly (Col. 11-12, lines 45-39)(Col. 7, lines 41-55); characterizing adherence of the intensity of light reflected off the meniscus to the threshold; and determining compliance of the component connected to the printed circuit board assembly based on the characterization of the adherence of the intensity of light reflected off the meniscus to the threshold (Col. 11-12, lines 45-39) for an optical inspection apparatus for printed circuit boards. It would have been obvious to combine the device of Schimanaski ('912) with the optical determination listed above with Sepai et al. ('870) for the purpose of providing an optical inspection apparatus that inspects the surface of a printed circuit board, therefore the inspection of defects on the surface which will decrease the amount of printed circuit boards that are have defects from being shipped the end user.

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# Allowable Subject Matter

5. Claims 4-6, 11-20 are objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Michael P. Stafira whose telephone number is 571-272-2430. The examiner can normally be reached on 4/10 Schedule Mon.-Thurs..

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Gregory Toatley can be reached on 571-272-2800 ext. 77. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Michael P Stafira Primary Examiner Art Unit 2877

March 28, 2006